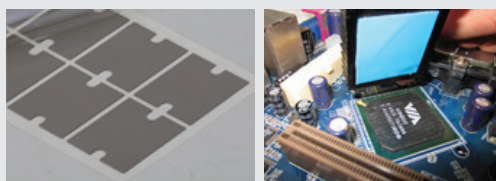


Technical Data Sheet

EverTherm non-silicone thermal pads are manufactured from an advanced resin. They will not damage or promote circuit failure and have no siloxane volatilization resulting in no silicone oil seeping. EverTherm Non Silicone pads exhibit low outgassing, excellent tensile and wear resistance.



Material Properties

- High thermal conductivity
- Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

Applications

- ✓ Semiconductor heat sink
- ✓ Electric Vehicle (EV) Batteries
- ✓ Communication & power devices & modules
- ✓ LED lighting equipment
- ✓ Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets



EVAF600G NON-SILICONE

Color	White	Visual
Thickness	0.5-5.0mm	ASTM D374
Specific Gravity	3.1g/cm ³	ASTM D792
Thermal Conductivity	6.0 W/m.k	ASTM D5470
Hardness(shore 00)	45-80	ASTM D2240
Elongation	50%	ASTM D412
Tensile Strength	30Psi	ASTM D412
Dielectric Breakdown Voltage	>8KV/mm	ASTM D149
Flammability Rating	94 V-0	UL
Volume Resistivity	10 ¹³ Ω.cm	ASTM D257
Operating Temperature	-40 - 125°C	---
Thermal Resistance(1mm,@40psi)	0.25°C*in ² /W	ASTM D5470
Compression Ratio(1mm,@40psi)	20%	---
RoHS	PASS	IEC 62321
Halogen	PASS	EN14582
REACH	PASS	EN14372
Standard Sheet Size (Note: Other sheet sizes may be available upon request.)		200 x 300mm

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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Note: The information provided herein is accurate at time of publication. It is the responsibility of the end-user to confirm compliance to their application. All test data is typical. Therefore, these recommendations and data are for reference only and not as a product warranty.